

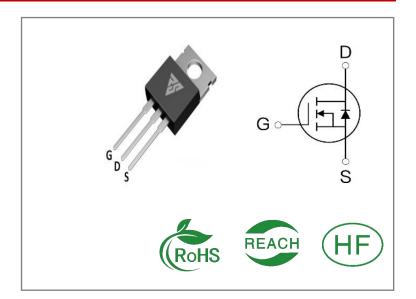
ID	R _{DS} (ON)(Typ)	VDSS
135A	3.7 m Ω	100V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part N	lumber	Package	Marking	Packing	Qty.
RS100	N135T	T0-220	RS100N135T	Tube	50 PCS

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS100N135T	Units
VDSS	Drain-to-Source Voltage	100	V
ID	Continuous Drain Current TC=25℃	135	
ID	Continuous Drain Current TC=100℃	105	Α
IDM	Pulsed Drain Current	600	
PD	Power Dissipation	225	W
VGS	Gate- to- Source Voltage	±20	٧
EAS	Single Pulse Avalanche Engergy L = 0.5mH,VDS = 50V, RG = 25 Ω , Tj = 25 $^{\circ}$ C	540	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	$^{\circ}$ C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS100N135T	Units	Test Conditions
RθJC	Junction-to-Case	0.55	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C
RθJA	Junction-to- Ambient	62		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	100			V	VGS=0V,ID=250μ A
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=80V,VGS=0 V
ICCC	Gate- to- Source Forward Leakage			100	- A	VGS=20V ,VDS=0 V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS= 0V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	Static Drain- to- Source On-		3.7	4.2	mΩ	VGS=10V,ID=80A
RDS(on)	Resistance	4.5 5.5 mΩ	VGS=4.5V,ID=20 A			
VGS(TH	Gate Threshold Voltage	2.5		3.5	V	VGS=VDS,ID=25 0μA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		25			VDS=50V ID=80A
trise	Rise Time		33			
td(OFF)	Turn- OFF Delay Time		95		nS	$RG=5\Omega$
tfall	Fall Time		75			VGS=10V



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		3950			VGS= 0V
Coss	Output Capacitance		1200		рF	VDS=25V
Crss	Reverse Transfer Capacitance		27			f=1MHz
Qg	Total Gate Charge		67			VDS= 50V
Qgs	Gate- to- Source Charge		17		nC	ID=80A
Qgd	Gate-to-Drain(" Miller") Charge		17			VGS=10V

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			135	Α	Integral pn- diode
ISM	Maximum Pulsed Current			600	Α	in MOSFET
VSD	Diode Forward Voltage			1.2	V	IS=80A,VGS=0V
trr	Reverse Recovery Time		82		nS	VDD=50V
Qrr	Reverse Recovery Charge		180		nC	IS=20A di/dt=100A/μs

Notes:

- * 1. Repetitive rating, pulse width limited by maximum junction temperature.
- * 2. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%

Typical Feature Curve

Figure 1. Output Characteristics (TJ= 25°C) Figure 2. Typ. drain-source on resistance 300 10V 9 250 200 Ron[mohm] 5.5V F 150 100 5V 50 4.5V 10V 4 100 50 150 200 250 VDS[V] ID[A]



Figure 3. Typ. transfer characteristics

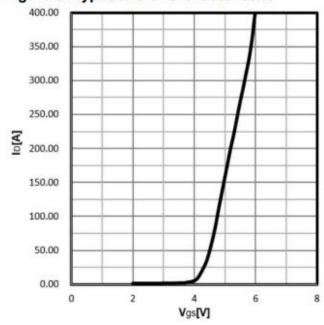


Figure 4. Typ. forward transconductance

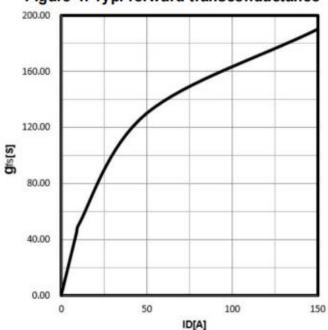
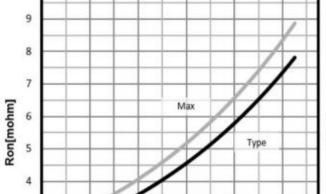


Figure 5. Drain-source on-state resistance



60

T[°C]

100

140

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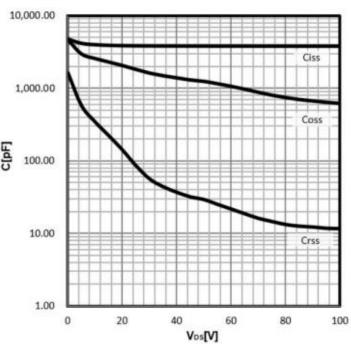
1

-60

-20

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Figure 6. Typ. capacitances





10°

Figure 7. Drain-source breakdown voltage Figure 8. Gate Charge 10 Vd=50.0V Vd=80.0V 8 Vd=100.0V 7 105 VBR(DSS) [V] 6 VgsM 5 4 100 3 2 -60 -20 20 60 100 140 0 T[C] Q₀[nC] 0 20 60

Figure 9. Transient Thermal Impedance

TO-220

TO-220

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Test ircuits and Waveforms

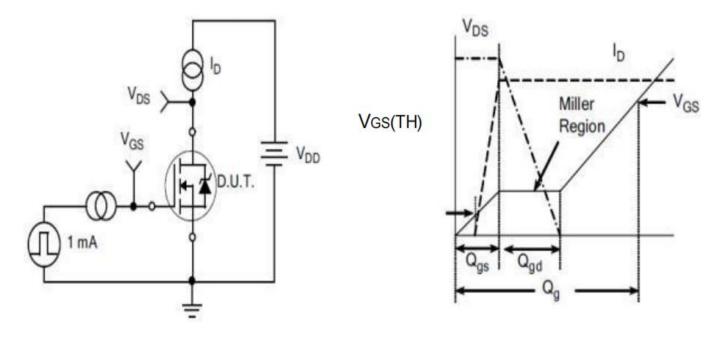


Figure A.
Gate Charge Test Circuit

V_{DS} V_{DS} D.U.T.

Figure C.
Resistive Switching Test Circuit

Figure B.
Gate Charge Waveform

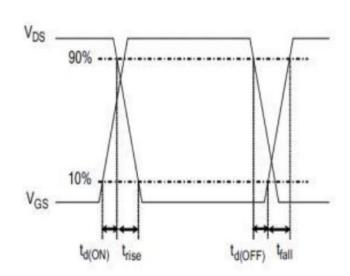
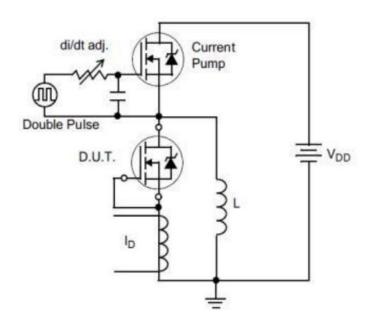


Figure D.
Resistive Switching Waveforms



Test ircuits and Waveforms



 $di/dt = 100A/\mu A$ Q_{rr}

Figure E.Diode Reverse Recovery Test Circuit

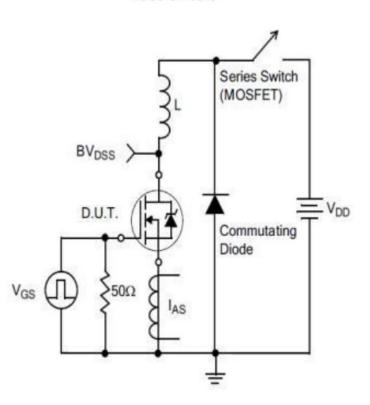


Figure F.Diode Reverse Recovery Waveform

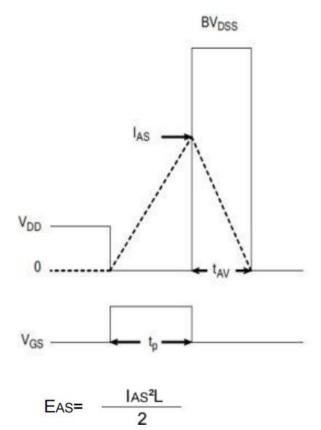
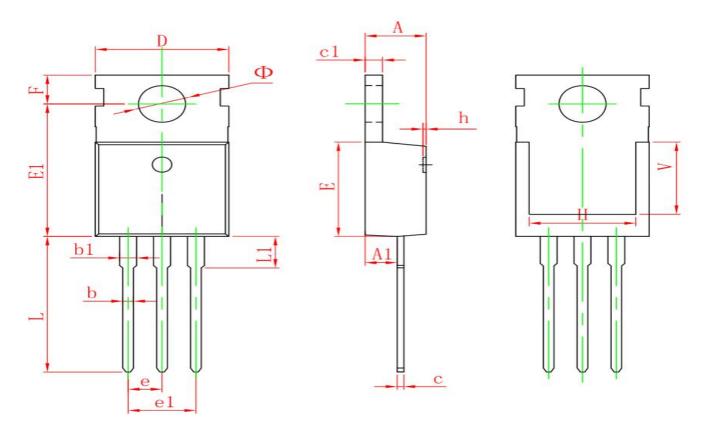


Figure G.Unclamped Inductive Switching Test Circuit

Figure H.Unclamped Inductive Switching Waveforms



Package outline drawing(TO-220 Unit: mm)



Cumbal	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
С	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
е	2.540	TYP.	0.100	TYP.
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
Н	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900	REF.	0.276	REF.
Ф	3.400	3.800	0.134	0.150



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DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 IPS60R360PFD7SAKMA1
DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
MCQ7328-TP SSM3J143TU,LXHF DMN12M3UCA6-7 PJMF280N65E1_T0_00201 PJMF380N65E1_T0_00201
PJMF280N60E1 T0 00201 PJMF600N65E1 T0 00201 PJMF900N65E1 T0 00201